



MOTIUS  
WE R&D.

## Our Approach

Motius GmbH

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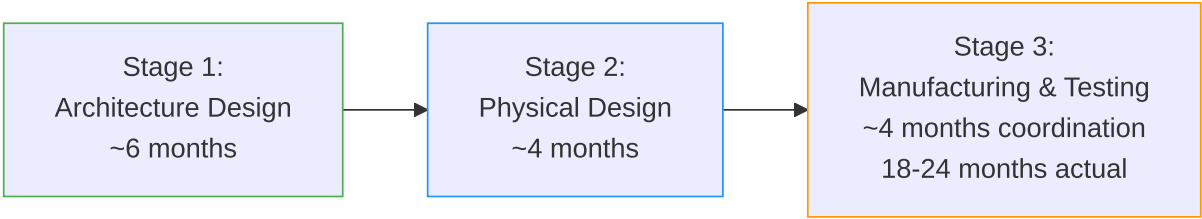


# Our Approach to Silicon Development

We bridge the gap between application requirements and manufactured silicon through proven FPGA prototyping and production integration expertise.

## The Silicon Journey

 Based on real experience manufacturing our own chip



### Stage 1: Architecture Design (~6 months)

From requirements to working FPGA prototype with RISC-V CPU integration, custom IP development, and comprehensive validation.

#### System Specification

Define performance targets, power budgets, interface requirements, and peripheral ecosystem

#### HDL Implementation

Design in Verilog/VHDL with RISC-V CPU integration and custom IP cores

#### Simulation & Testing

Functional verification, timing analysis, and resource optimization

### **FPGA Prototyping**

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Working hardware demonstration on AMD Xilinx platforms

**Tools & Technologies:** Vivado, Synplify, Design Compiler, Precision FPGA Synthesis, Questa One Sim

**Key Deliverables:** System architecture specification, synthesizable HDL code, validated FPGA prototype, test suite and documentation

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## **Stage 2: Physical Design (~4 months)**

ASIC-ready design with PDK compliance, timing closure, and tape-out preparation.

### **Floorplanning & Placement**

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Strategic placement of functional units, memory blocks, and I/O pads

### **Tapeout Verification**

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DRC/LVS checks, timing closure, and manufacturing rule compliance

### **PDK & Standard Cells**

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Process Design Kit verification and standard cell library integration

### **Manufacturing Prep**

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GDSII generation, documentation package, foundry submission files


**Tools & Technologies:** PrimeTime, Innovus Implementation System, foundry-specific PDKs

**Key Deliverables:** Floorplan layout, verified GDSII files, timing reports, manufacturing documentation


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### Stage 3: Manufacturing & Testing (~4 months coordination | 18-24 months actual)


Foundry coordination, manufacturing oversight, and post-silicon validation.

 Foundry Coordination


IC manufacturing management with wafer selection and die packaging

 Silicon Production

Wafer fabrication, die cutting, packaging, and assembly

 Post-Silicon Testing

Electrical validation, functional testing, and defect analysis

 Debug & Recovery

Issue identification and mitigation strategies for manufacturing defects

Manufacturing Partners:

Region	Partners
German/EU	Fraunhofer IIS, RoodMicrotec, Racyics, TES Electronic Solutions, iC-Haus, Infineon
Global Foundries	TSMC, Samsung, GlobalFoundries
Open-Source	Google/efabless shuttle programs

**Reality Check:** 18-24 months from submission to working chips (we know because we've done it before)

**Key Deliverables:** Manufactured chips, test reports, characterization data, production-ready design

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# Service Offerings

 **RISC-V FPGA Platform Development**

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**€100-200K | 4-6 months**

Working FPGA reference platform with RISC-V CPU, peripherals, and demo applications

 **Custom IP Core Development**

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**€80-150K | 3-5 months**

Hardware-accelerated IP cores (FFT, CRC, ML acceleration) integrated and verified

 **FPGA-to-ASIC Preparation**

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**€150-300K | 4-6 months**

ASIC-ready design with feasibility study, partner introduction, and tape-out prep

 **Requirements Engineering**

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**€40-80K | 6-10 weeks**

Feasibility report with business case, architecture options, and implementation roadmap

 **Production Integration**

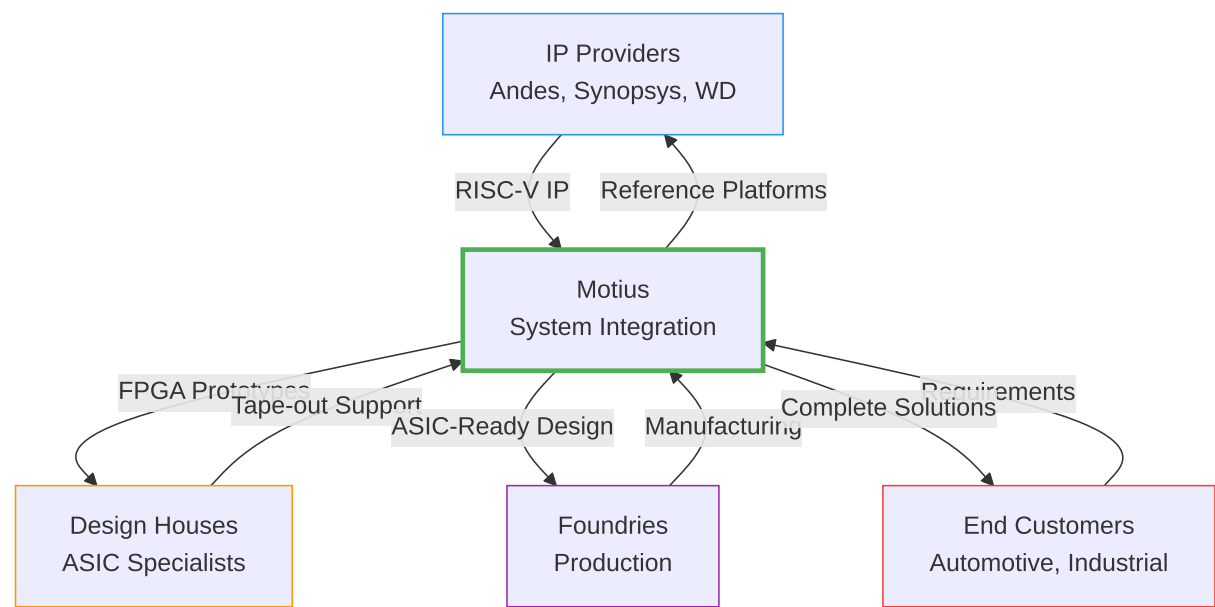
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**€200-400K | 8-12 months**

Production-ready hardware with CE, EMC, and safety certifications (IEC 61508 SIL2)

# Partnership Model

We work with (not against) the ecosystem



## Why Work With Us

### We've Manufactured Our Own Chip

Real tape-out experience, debugged manufacturing defects, understand true timelines

### Multi-Vendor RISC-V Experience

Proven with Andes, Synopsys ARC-V, Western Digital cores across multiple platforms

### Production-Ready Systems

2M+ units shipped, CE/EMC certified, IEC 61508 SIL2 functional safety experience

### Full-Stack Capability

From application requirements → FPGA → ASIC → production hardware → certifications

## Who We Work With

Customer Type	How We Help
<b>Automotive &amp; Industrial Companies</b>	Evaluate if custom silicon makes business sense, FPGA prototyping to de-risk decisions, production integration with certifications
<b>IP Providers &amp; SoC Designers</b>	Reference platform development, customer demonstration support, application expertise

**Sweet spot:** Mid-size manufacturers (€50M–500M revenue), 5,000–50,000 units/year

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